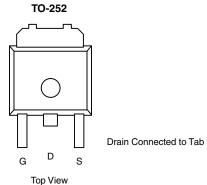


Vishay Siliconix

N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A)	Q _g (Typ.)	
100	0.066 at V _{GS} = 10 V	18.2	19.8	
100	0.080 at V_{GS} = 4.5 V	13.2	19.0	





TrenchFET[®] Power MOSFET •

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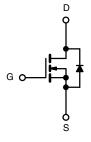
100 % $\rm R_{g}$ and UIS Tested Material categorization: For definitions of compliance please see



HALOGEN FREE

APPLICATIONS

- DC/DC Converters ٠
- **DC/AC** Inverters
- Motor Drives



N-Channel MOSFET

Ordering Information:

SUD20N10-66L-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)				
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	v
Gate-Source Voltage		V _{GS}	± 20	v
Continuous Drain Current	T _C = 25 °C		16.9	
Continuous Drain Current	T _C = 70 °C	I _D	13.6	•
Pulsed Drain Current (t = 300 µs)		I _{DM}	25	- A
Avalanche Current		I _{AS}	15	
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	11.25	mJ
Maximum Power Dissipation ^a	T _C = 25 °C	P	41.7 ^b	w
	T _A = 25 °C ^c	P _D	2.1	vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	60	°C/W	
Junction-to-Case (Drain)	R _{thJC}	3		

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR-4 material).

d. Base on T_C = 25 °C.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100			v
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		3	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA
Zero Gate Voltage Drain Current		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
	I _{DSS}	I_{DSS} $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50	μA
		V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 150 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α
Drain Course On State Desistance	D	V _{GS} = 10 V, I _D = 6.6 A		0.055	0.066	0
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 6 \text{ A}$		0.066	0.080	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 6.6 A		25		S
Dynamic ^b	·					
Input Capacitance	C _{iss}			860		pF
Output Capacitance	C _{oss}	$V_{DS} = 50$ V, $V_{GS} = 0$ V, f = 1 MHz		85		
Reverse Transfer Capacitance	C _{rss}			40		
Total Gate Charge ^c	Qg			19.8	30	nC
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 6.6 \text{ A}$		3.6		
Gate-Drain Charge ^c	Q _{gd}			4.1		
Gate Resistance	Rg	f = 1 MHz	0.4	2	4	Ω
Turn-On Delay Time ^c	t _{d(on)}			8	16	-
Rise Time ^c	t _r	V_{DD} = 50 V, R_{L} = 9.6 Ω		11	20	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 5.2$ Å, $V_{GEN} = 10$ V, $R_g = 1 \Omega$		18	27	1
Fall Time ^c	t _f			5	10	
Turn-On Delay Time ^c	t _{d(on)}			38	57	ns
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{L} = 9.6 \Omega$		58	87	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ 5.2 A, V_{GEN} = 4.5 V, R_g = 1 Ω		18	27	
Fall Time ^c	t _f			8	16	1
Drain-Source Body Diode Ratings a	nd Characteri	stics ^b T _C = 25 °C				
Continuous Current	۱ _S				16.9	٨
Pulsed Current	I _{SM}				25	A
Forward Voltage ^a	V _{SD}	I _F = 5.2 A, V _{GS} = 0 V		0.8	1.5	V
Reverse Recovery Time	t _{rr}			34	51	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 5.2 A, dI/dt = 100 A/μs		3	5	Α
Reverse Recovery Charge	Q _{rr}]		50	75	nC

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

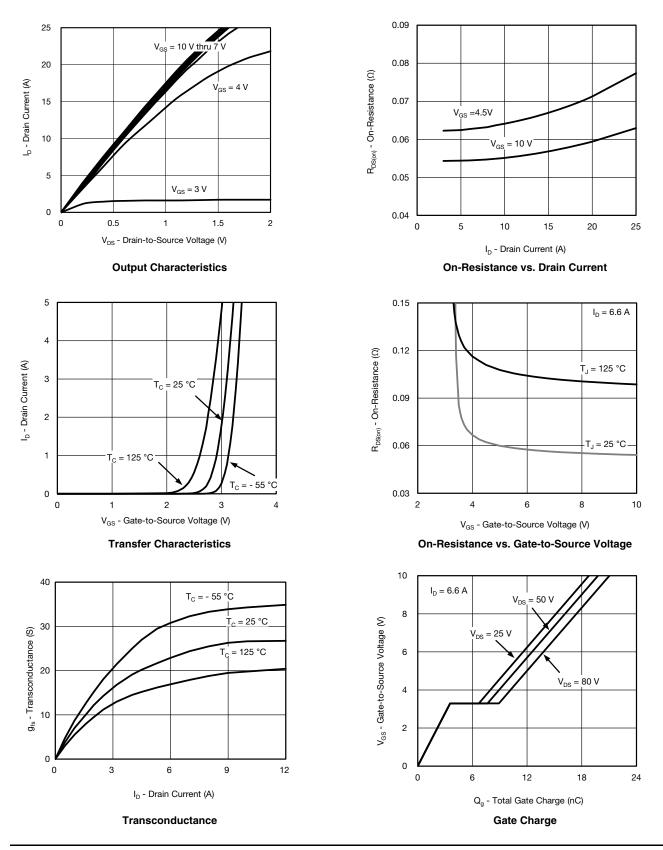
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

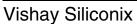


Document Number: 62815 S13-0629-Rev. A, 25-Mar-13

For technical questions, contact: pmostechsupport@vishay.com

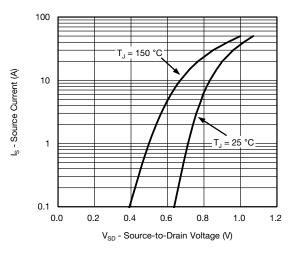
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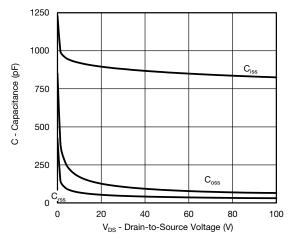




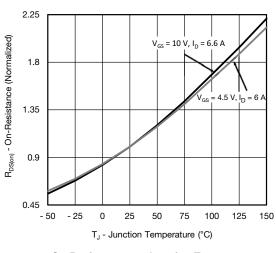
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



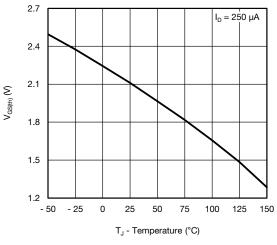
Source-Drain Diode Forward Voltage



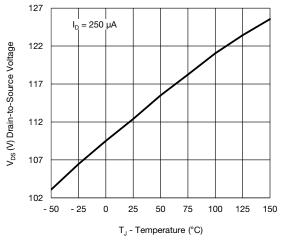




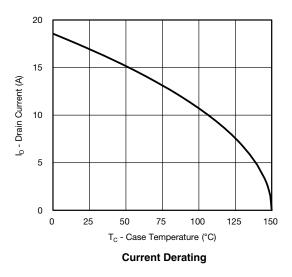
On-Resistance vs. Junction Temperature



Threshold Voltage



Drain Source Breakdown vs. Junction Temperature

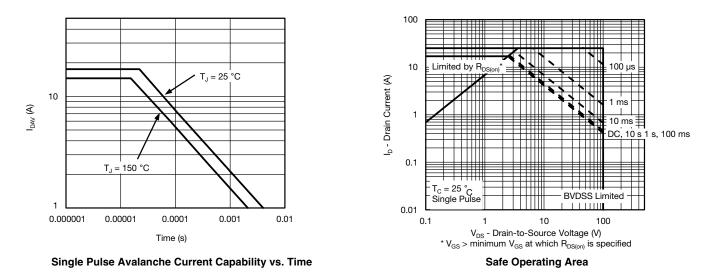


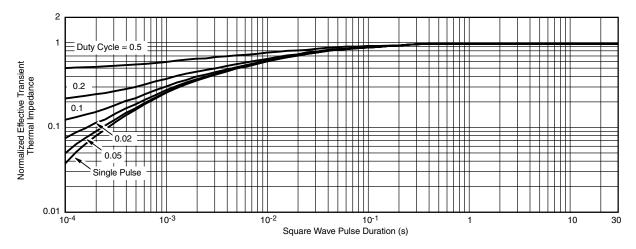
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Normalized Thermal Transient Impedance, Junction-to-Case

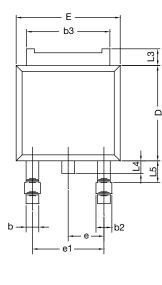
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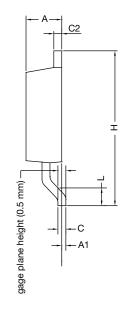




TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

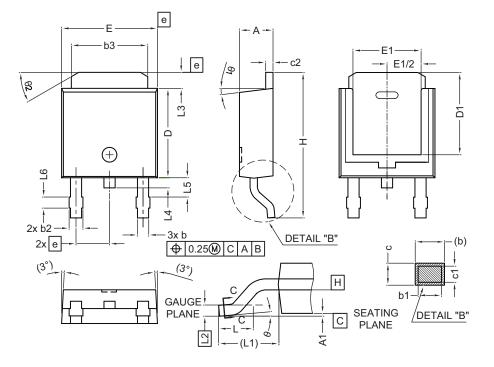
Note

• Dimension L3 is for reference only



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VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
с	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32	-	
e	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74 ref.		
L2	0.51 BSC		
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

Dimensioning and tolerance confirm to ASME Y14.5M-1994

All dimensions are in millimeters. Angles are in degrees

Heat sink side flash is max. 0.8 mm

Radius on terminal is optional ٠

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347



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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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